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| APPLICATION NO.  | FILING DATE     | FIRST NAMED INVENTOR | ATTORNEY DOCKET NO.    | CONFIRMATION NO. |
|--|-----------------|----------------------|------------------------|------------------|
| 10/604,133   | 06/27/2003      | Masuhiro Natsuhara   | 39.017-AG              | 1132             |
| 29453 75   | 90 11/14/2006   |                      | EXAMINER               |                  |
|  | JRAKAMI IP ASSO | KACKAR               | KACKAR, RAM N          |                  |
| DOJIMIA BUILDING, 7TH FLOOR<br>6-8 NISHITEMMA 2-CHOME, KITA-KU |                 | ART UNIT             | PAPER NUMBER           |                  |
| OSAKA-SHI,   |                 |                      |                        |                  |
| JAPAN  |                 |                      | DATE MAILED: 11/14/200 | 6                |

Please find below and/or attached an Office communication concerning this application or proceeding.

| •   |   | Application No.   | Applicant(a)   |
|---|---|---|--|
| •   |   |   | Applicant(s)   |
|   | Office Action Summary   | 10/604,133  | NATSUHARA ET AL.   |
|   | Office Action Summary   | Examiner  | Art Unit   |
|   | The MAN WO DATE ON  | Ram N. Kackar   | 1763   |
| Period fo   | The MAILING DATE of this communication app<br>or Reply  | pears on the cover sheet with the c   | orrespondence address  |
| WHIC<br>- Exter<br>after<br>- If NC<br>- Failu<br>Any | ORTENED STATUTORY PERIOD FOR REPLY CHEVER IS LONGER, FROM THE MAILING DANSIONS of time may be available under the provisions of 37 CFR 1.13 SIX (6) MONTHS from the mailing date of this communication. Operiod for reply is specified above, the maximum statutory period we are to reply within the set or extended period for reply will, by statute, reply received by the Office later than three months after the mailing ed patent term adjustment. See 37 CFR 1.704(b). | ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from the cause the application to become ABANDONE | N. nely filed the mailing date of this communication. D (35 U.S.C. § 133). |
| Status  |   | •   |  |
| 2a) <u></u>   | Since this application is in condition for allowar  | action is non-final.  |  |
|   | closed in accordance with the practice under E  | x parte Quayle, 1935 C.D. 11, 45  | i3 O.G. 213.   |
| Dispositi   | on of Claims  |   |  |
| 5)□<br>6)⊠<br>7)⊡                                     | Claim(s) <u>1-5</u> is/are pending in the application.  4a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed.  Claim(s) <u>1-5</u> is/are rejected.  Claim(s) is/are objected to.  Claim(s) are subject to restriction and/or  |   |  |
| Applicati   | on Papers   |   |  |
| 10)□  | The specification is objected to by the Examiner The drawing(s) filed on is/are: a) acce Applicant may not request that any objection to the of Replacement drawing sheet(s) including the correction The oath or declaration is objected to by the Example.  | epted or b) objected to by the Edrawing(s) be held in abeyance. See ion is required if the drawing(s) is obj  | e 37 CFR 1.85(a).<br>ected to. See 37 CFR 1.121(d).                        |
| Priority u  | ınder 35 U.S.C. § 119   |   |  |
| 12) <u></u> a)[                                       | Acknowledgment is made of a claim for foreign All b) Some * c) None of:  1. Certified copies of the priority documents  2. Certified copies of the priority documents  3. Copies of the certified copies of the priori application from the International Bureau see the attached detailed Office action for a list of  | s have been received. s have been received in Application ity documents have been receive I (PCT Rule 17.2(a)).   | on No<br>d in this National Stage  |
| 2) 🔲 Notice<br>3) 🔯 Inform                            | e of References Cited (PTO-892) e of Draftsperson's Patent Drawing Review (PTO-948) nation Disclosure Statement(s) (PTO/SB/08) r No(s)/Mail Date 6/15/2006.   | 4) Interview Summary ( Paper No(s)/Mail Da 5) Notice of Informal Pa 6) Other:   | te   |

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#### **DETAILED ACTION**

## Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on 9/21/2006 has been entered.

### Claim Rejections - 35 USC § 112

2. The following is a quotation of the first paragraph of 35 U.S.C. 112:

The specification shall contain a written description of the invention, and of the manner and process of making and using it, in such full, clear, concise, and exact terms as to enable any person skilled in the art to which it pertains, or with which it is most nearly connected, to make and use the same and shall set forth the best mode contemplated by the inventor of carrying out his invention.

Claims 1-5 are rejected under 35 U.S.C. 112, first paragraph, as failing to comply with the written description requirement.

The claim(s) contains subject matter which was not described in the specification in such a way as to reasonably convey to one skilled in the relevant art that the inventor(s), at the time the application was filed, had possession of the claimed invention. In this instance the newly added limitation in claim 1 of "the electrodes having a length of at least half the diameter of the wafer carrying surface" is a new matter. The specification, even though it may show an occurrence of a certain length of electrodes and wafer holder diameter, which would satisfy the claimed relationship, does not disclose this relation ship as axiom. Applicant's characterization of this single occurrence as an axiomatic generalization is improper. Further, it is possible to find

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electrodes of length, which do not conform to claimed relation ship but perfectly conform to invention as stated in abstract and summary of invention.

Further in claim 5 recitation of "heat capacity of each of the plurality of electrodes is 1% or less....." is also a new matter.

3. The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

Claims 1-5 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.

In theses claims the new limitation of electrode length is indefinite since the two ends of this length are not known with certainty. One end of the electrode (a wire to connect power to the electrical circuitry) is to be connected to the circuit but the other end connected to the source of power may be at unknown distance.

#### Claim Rejections - 35 USC § 103

- 4. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

5. Claims 1-5 are rejected under 35 U.S.C. 103(a) as being unpatentable over Araki et al (US 6239402) in view of Ohashi et al (US 6261708) as evidenced by Soma et al (US 5231690) and also further in view of Yasutaka Ito (JP 2002-249377).

Araki et al disclose an Aluminum Nitride based wafer holder for semiconductor manufacturing device (Fig 8) with a shaft (28) or wafer holder (Fig 9) with a shaft (34) and an electrical circuit formed inside (7 for resistive heating and 9 for plasma) and electrodes for supplying power (12, 13 and 14). The heat capacity of the electrodes could be fairly estimated to be less than 2 J/gK, since compared to the claimed invention the wire (electrodes) number is 3 and length less than 40mm.

This estimation depends upon the typical diameter of power supplying electrodes being 4mm. Typical diameter as taught by Soma et al is 2mm (Col 6 lines 7-10). It may be fairly estimated that even if the diameter is several times that of Soma et al the heat capacity of electrodes will not be more than 5 J/gK.

The heat capacity of the wafer holder however could be fairly estimated to be more than 350 J/gK for wafer holder of Fig 9 and much larger for the wafer holder of Fig 8. Therefore the heat capacity of the electrodes of the disclosed wafer holder would be much less than 10%.

Further Araki et al do not disclose the degree of roughness of the surfaces of the shaft and the wafer holder.

Ohashi et al teach a method of joining a shaft and a wafer holder and teach that respective surfaces are smoothed to less than 2  $\mu$ m (Col 10 lines 22-28) for airtight joining.

Therefore it would have been obvious for one of ordinary skill in the art at the time of invention to have smooth joining surface for a good joint.

Regarding the limitation of the electrodes length, in this instance electrodes are understood to be the conductor from the electrical circuit to the power supply and would be configured according to component placements and process needs and would therefore be obvious to be optimized.

Further, references disclosed by the applicant in IDS specially Yasutaka Ito, recommend low heat capacity (Paragraph 9-10) and explain that large heat capacity increases the amount of heat required to raise the temperature. Therefore it would be obvious to optimize the heat capacity of the electrodes with respect to the wafer holder since regions with large heat capacity will have less comparative temperature and low temperature uniformity.

### Response to Arguments

Applicant's arguments filed 9/21/2006 have been fully considered but they are not persuasive.

Applicants new limitations are addressed in the rejection as discussed above.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Ram N. Kackar whose telephone number is 571 272 1436. The examiner can normally be reached on M-F 8:00 A.M to 5:P.M.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Parviz Hassanzadeh can be reached on 571 272 1435. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent

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Application Information Retrieval (PAIR) system. Status information for published applications

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system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR

system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Ram Kackar

Primary Examiner AU 1763